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FLS6617 Primary-Side-Regulation PWM with POWER MOSFET Integrated

Features

- Low Standby Power under 30 mW
- High-Voltage Startup
- Fewest External Component Counts
- Constant-Voltage (CV) and Constant-Current (CC) Control without Secondary-Feedback Circuitry
- Green-Mode: Linearly Decreasing PWM Frequency with Cycle Skipping
- Fixed PWM Frequency at 50 kHz with Proprietary Frequency Hopping to Solve EMI Problem
- Peak-Current-Mode Control in CV Mode
- Cycle-by-Cycle Current Limiting
- V_{DD} Over-Voltage Protection with Auto Restart
- V_{DD} Under-Voltage Lockout (UVLO)
- Gate Output Maximum Voltage Clamped at 15 V
- Fixed Over-Temperature Protection with Auto Restart
- Available in the 7-Lead SOP Package

Applications

- Battery chargers for cellular phones, cordless phones, PDA, digital cameras, power tools, etc.
- Replaces linear transformers and RCC SMPS

Related Resources

- [Fairchild Power Supply WebDesigner — Flyback Design & Simulation - In Minutes at No Expense](#)

Description

This third-generation Primary Side Regulation (PSR) and highly integrated PWM controller provides several features to enhance the performance of low-power flyback converters. The proprietary TRUECURRENT[®] technology of FLS6617 enables precise CC regulation and simplified circuit design for battery-charger applications leading to lower-cost, smaller, and lighter chargers, compared to a conventional design or a linear transformer.

To minimize standby power consumption, the proprietary green mode provides off-time modulation to linearly decrease PWM frequency under light-load conditions. Green mode assists the power supply in meeting power conservation requirements.

By using the FLS6617, a charger can be implemented with few external components and minimized cost. A typical output CV/CC characteristic envelope is shown in Figure 1.

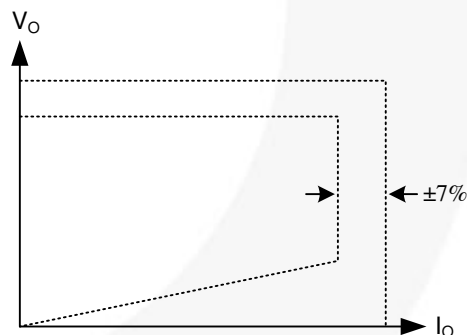


Figure 1. Typical Output V-I Characteristic

Ordering Information

Part Number	Operating Temperature Range	Package	Packing Method
FLS6617MX	-40°C to +125°C	7-Lead, Small Outline Package (SOP-7)	Tape & Reel

Application Diagram

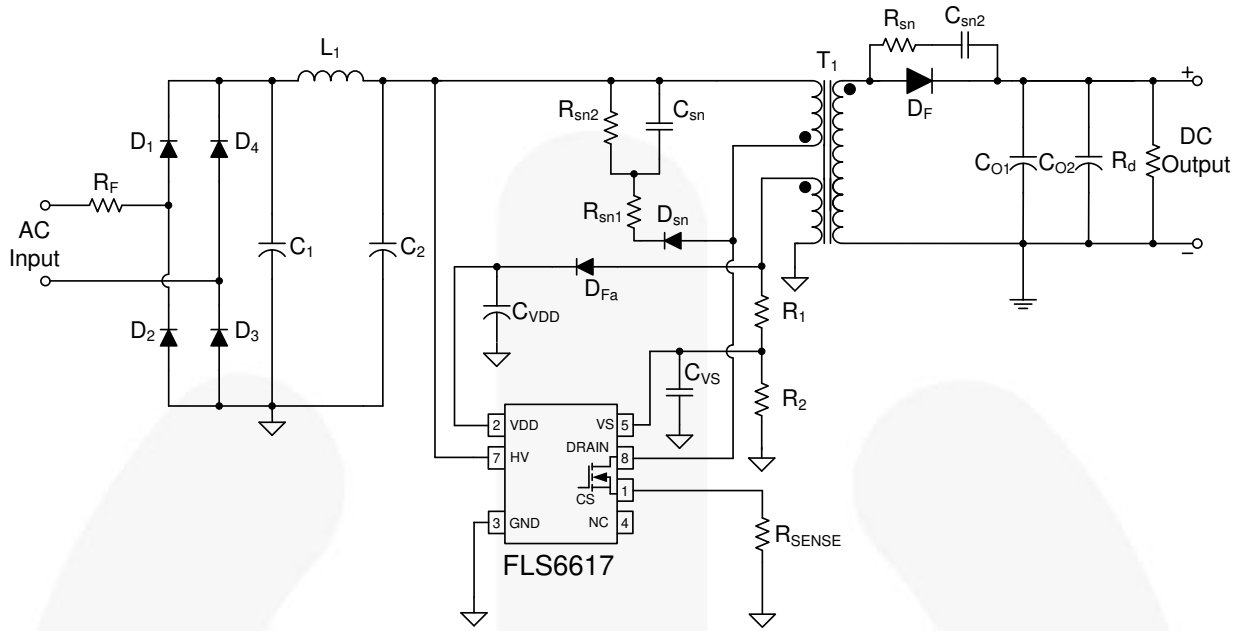


Figure 2. Typical Application

Internal Block Diagram

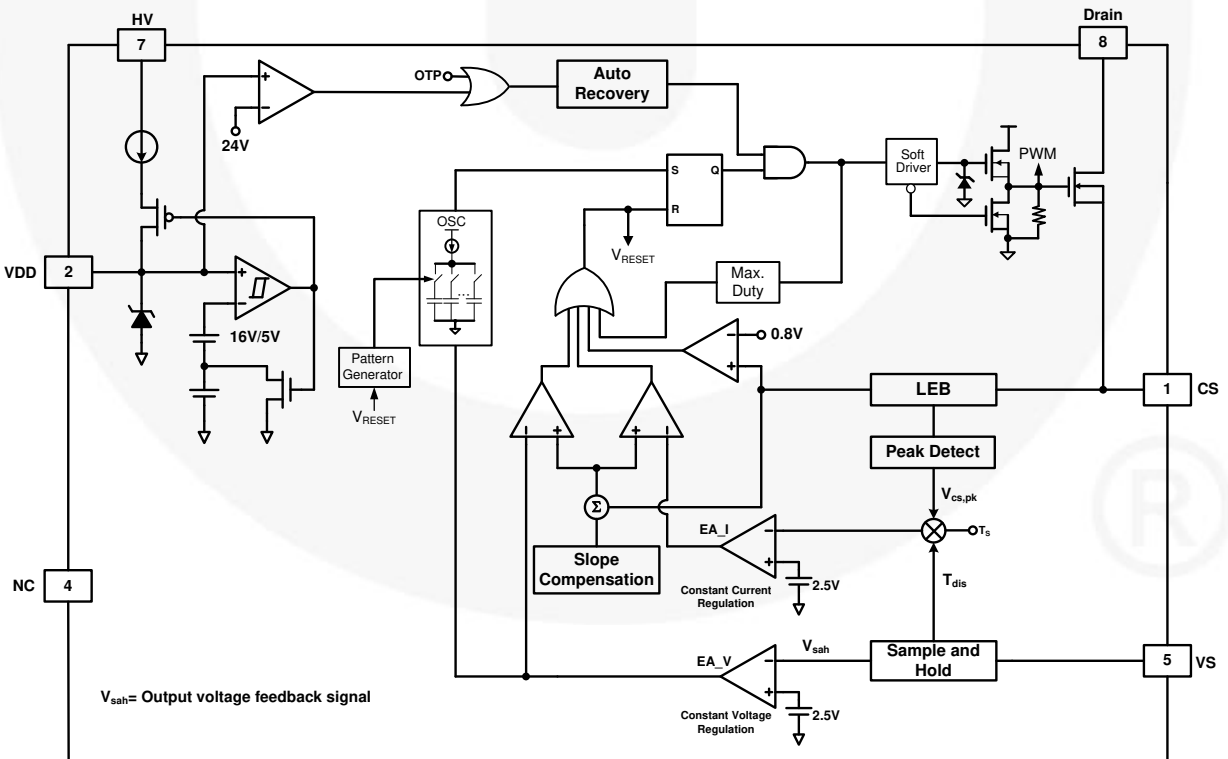
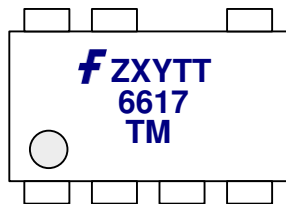


Figure 3. Functional Block Diagram

Marking Information



F: Fairchild Logo
 Z: Plant Code
 X: 1-Digit Year Code
 Y: 1-Digit Week Code
 TT: 2-Digit Die Run Code
 T: Package Type (M=SOP)
 M: Manufacture Flow Code

Figure 4. Top Mark

Pin Configuration

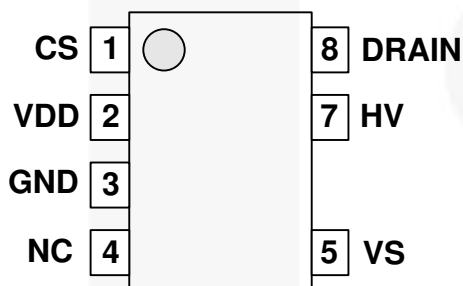


Figure 5. Pin Configuration

Pin Definitions

Pin #	Name	Description
1	CS	Current Sense. This pin connects to current-sense resistor. Detect the MOSFET current for peak-current-mode control in CV mode and provide the output-current regulation in CC mode.
2	VDD	Power Supply. IC operating current and MOSFET driving current are supplied through this pin. This pin is connected to an external V_{DD} capacitor of typically 10 μ F. The threshold voltages for startup and turn-off are 16 V and 5 V, respectively. The operating current is lower than 5 mA.
3	GND	Ground
4	NC	No Connection
5	VS	Voltage Sense. This pin detects the output voltage information and discharge time based on voltage of auxiliary winding.
7	HV	High Voltage. This pin connects to bulk capacitor for high-voltage startup.
8	DRAIN	Driver Output. Power MOSFET drain. This pin is the high-voltage power MOSFET drain.

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Units
V _{HV}	HV Pin Input Voltage			500	V
V _{VDD}	DC Supply Voltage ^(1,2)			30	V
V _{VS}	VS Pin Input Voltage		-0.3	6.0	V
V _{CS}	CS Pin Input Voltage		-0.3	6.0	V
V _{COMV}	Voltage Error Amplifier Output Voltage		-0.3	6.0	V
V _{COMI}	Current Error Amplifier Output Voltage		-0.3	6.0	V
V _{DS}	Drain-Source Voltage			700	V
I _D	Continuous Drain Current	T _A =25°C		1	A
		T _A =100°C		0.6	A
I _{DM}	Pulsed Drain Current			4	A
E _{AS}	Single Pulse Avalanche Energy			50	mJ
I _{AR}	Avalanche Current			1	A
P _D	Power Dissipation (T _A <50°C)			660	mW
θ _{JA}	Thermal Resistance (Junction-to-Air)			147	°C/W
Ψ _{JT}	Thermal Resistance (Junction-to-Case)			11	°C/W
T _J	Operating Junction Temperature		-40	+150	°C
T _{STG}	Storage Temperature Range		-55	+150	°C
T _L	Lead Temperature (Wave Soldering or IR, 10 Seconds)			+260	°C
ESD	Electrostatic Discharge Capability (Except HV Pin)	Human Body Model, JEDEC-JESD22_A114	4.0		kV
		Charged Device Model, JEDEC-JESD22_C101	2.0		

Notes:

1. Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device.
2. All voltage values, except differential voltages, are given with respect to the GND pin.

Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Min.	Max.	Units
T _A	Operating Ambient Temperature	-40	+125	°C

Electrical Characteristics

Unless otherwise specified, $V_{DD}=15\text{ V}$ and $T_A=25^\circ\text{C}$.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit	
V_{DD} Section							
V _{OP}	Continuously Operating Voltage				23	V	
V _{DD-ON}	Turn-On Threshold Voltage		15	16	17	V	
V _{DD-OFF}	Turn-Off Threshold Voltage		4.5	5.0	5.5	V	
I _{DD-OP}	Operating Current			2.5	5.0	mA	
I _{DD-GREEN}	Green-Mode Operating Supply Current			0.95	1.2	mA	
V _{DD-OVP}	V _{DD} Over-Voltage-Protection Level (OVP)			24		V	
t _{D-VDDOVP}	V _{DD} Over-Voltage-Protection Debounce Time		90	200	350	μs	
HV Startup Current Source Section							
V _{HV-MIN}	Minimum Startup Voltage on HV Pin ⁽³⁾				50	V	
I _{HV}	Supply Current Drawn from HV Pin	V _{AC} =90 V (V _{DC} =100 V), V _{DD} =0 V	1	2.0	5.0	mA	
I _{HV-LC}	Leakage Current after Startup	HV=500 V, V _{DD} =V _{DD-OFF} +1 V		0.5	3.0	μA	
Oscillator Section							
f _{OSC}	Normal Frequency 1	Center Frequency	>V _O *0.78	44	50	56	kHz
		Frequency Hopping Range		±1.6	±3.4	±5.2	
	Normal Frequency 2	Center Frequency	<V _O *0.78		36		
		Frequency Hopping Range			±2.5		
V _{F-JUM-53}	Frequency Jumping Point	50 kHz→36 kHz, V _S	1.75	1.95	2.15	V	
V _{F-JUM-35}		36 kHz→50 kHz, V _S	2.05	2.25	2.45	V	
f _{OSC-N-MIN}	Minimum Frequency at No-Load		270	395	520	Hz	
f _{OSC-CM-MIN}	Minimum Frequency at CCM			13		kHz	
V _{S-F-SKIPH}	COMV Level for High Cycle Skipping Period Change ⁽³⁾			1.14		V	
V _{S-F-SKIPL}	COMV Level for Low Cycle Skipping Period Change ⁽³⁾			0.80		V	
T _{SKIP-CV}	Cycle skipping period ⁽³⁾	V _{S-F-SKIPH} <COMV<V _N		240		ms	
		V _{S-F-SKIPL} >COMV		160		ms	
f _{DV}	Frequency Variation vs. V _{DD} Deviation	V _{DD} =10 V, 25 V		1	2	%	
f _{DT}	Frequency Variation vs. Temperature Deviation	T _A =-40°C to 105°C			15	%	
Voltage-Sense Section							
I _{tc}	IC Bias Current			10		μA	
V _{BIAS-COMV}	Adaptive Bias Voltage Dominated by V _{COMV}	R _{VS} =20 kΩ		1.4		V	

Continued on the following page...

Electrical Characteristics

Unless otherwise specified, $V_{DD}=15\text{ V}$ and $T_A=25^\circ\text{C}$.

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
Current-Sense Section						
t_{PD}	Propagation Delay to GATE Output			90	200	ns
t_{MIN-N}	Minimum On Time at No-Load		700	850	1050	ns
V_{TH}	Threshold Voltage for Current Limit			0.8		V
Voltage Error Amplifier Section						
V_{VR}	Reference Voltage		2.475	2.500	2.525	V
V_N	Green-Mode Starting Voltage on EA_V	$f_{OSC}=\text{Normal Frequency}1 - 2\text{ kHz}$		2.5		V
V_G	Green-Mode Ending Voltage on EA_V	$f_{OSC}=1\text{ kHz}$		0.5		V
Current Error Amplifier Section						
V_{IR}	Reference Voltage		2.475	2.500	2.525	V
Internal MOSFET Section⁽⁴⁾						
DCY_{MAX}	Maximum Duty Cycle		60	75	85	%
BV_{DSS}	Drain-Source Breakdown Voltage	$I_D=250\ \mu\text{A}, V_{GS}=0\text{ V}$	700		900	V
$\Delta BV_{DSS}/\Delta T_J$	Breakdown Voltage Temperature Coefficient	$I_D=250\ \mu\text{A}$, Referenced to $T_A=25^\circ\text{C}$		0.53		V/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$I_D=0.5\text{ A}, V_{GS}=10\text{ V}$		13	16	Ω
I_S	Maximum Continuous Drain-Source Diode Forward Current				1	A
I_{DSS}	Drain-Source Leakage Current	$V_{DS}=700\text{ V}, T_A=25^\circ\text{C}$			10	μA
		$V_{DS}=560\text{ V}, T_A=100^\circ\text{C}$			100	μA
t_{D-ON}	Turn-On Delay Time	$V_{DS}=350\text{ V}, I_D=1\text{ A}$, $R_G=25\ \Omega^{(5)}$		10	30	ns
t_{D-OFF}	Turn-Off Delay Time			20	50	ns
C_{ISS}	Input Capacitance	$V_{GS}=0\text{ V}, V_{DS}=25\text{ V}$, $f_S=1\text{ MHz}$		175	200	pF
C_{OSS}	Output Capacitance			23	25	pF
Over-Temperature-Protection Section						
T_{OTP}	Threshold Temperature for OTP ⁽⁶⁾			+140		$^\circ\text{C}$

Notes:

3. Guaranteed by design.
4. These parameters, although guaranteed, are not 100% tested in production.
5. Pulse test: pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
6. When the over-temperature protection is activated, the power system enter auto-restart mode and output is disabled.

Typical Performance Characteristics

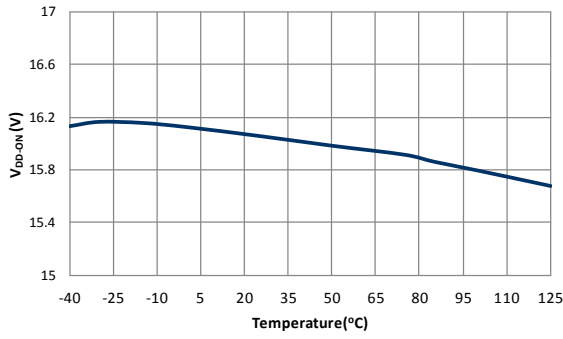


Figure 6. Turn-on Threshold Voltage (V_{DD-ON}) vs. Temperature

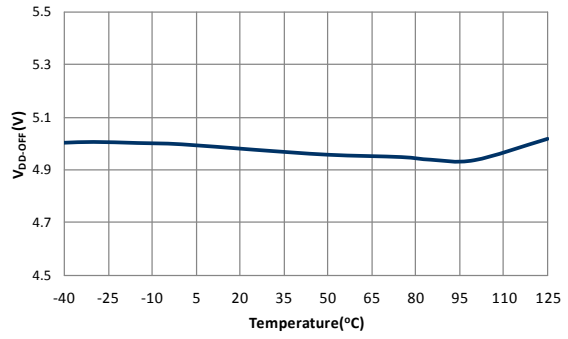


Figure 7. Turn-off Threshold Voltage (V_{DD-OFF}) vs. Temperature

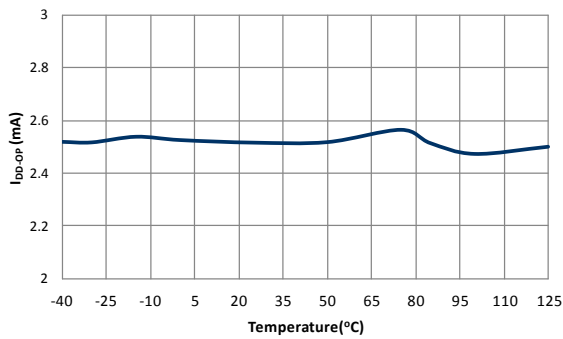


Figure 8. Operating Current (I_{DD-OP}) vs. Temperature

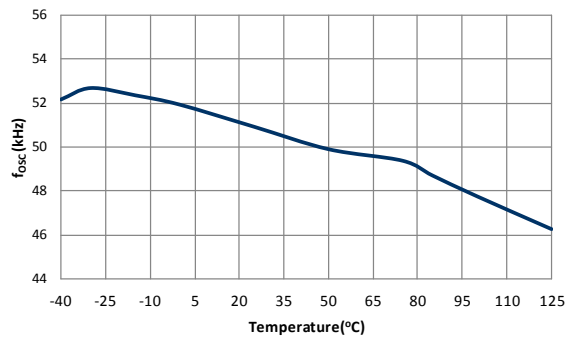


Figure 9. Normal Frequency 1 (f_{OSC}) vs. Temperature

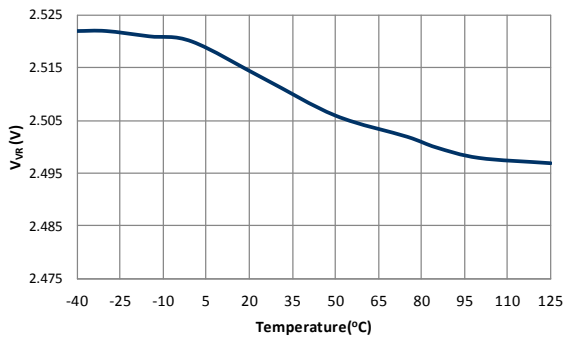


Figure 10. Reference Voltage (V_{VR}) vs. Temperature

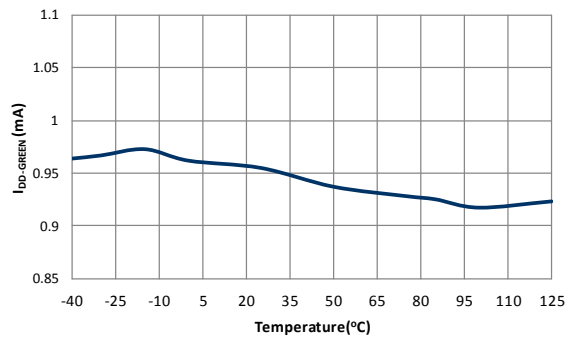


Figure 11. Green Mode Operating Supply Current (I_{DD-GREEN}) vs. Temperature

Typical Performance Characteristics

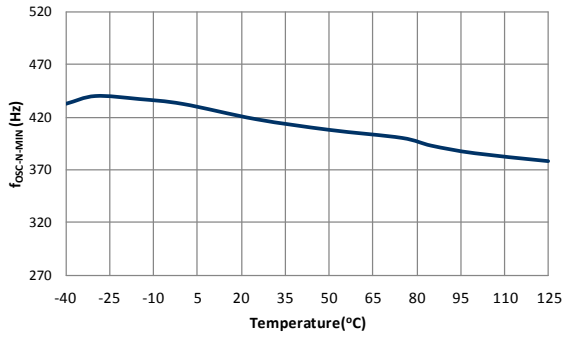


Figure 12. Minimum Frequency at No Load (f_{OSC-N-MIN}) vs. Temperature

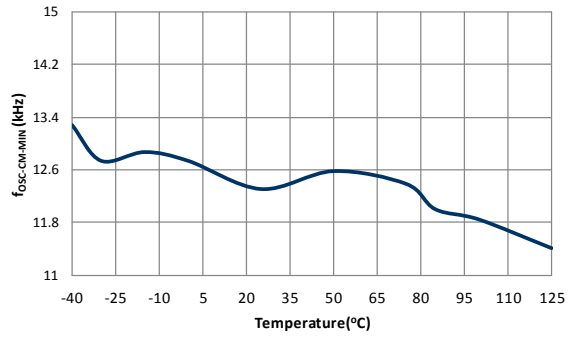


Figure 13. Minimum Frequency at CCM (f_{OSC-CM-MIN}) vs. Temperature

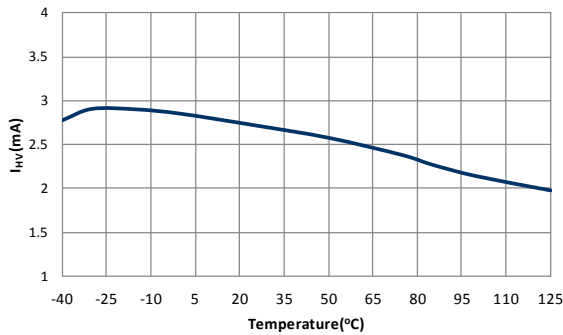


Figure 14. Supply Current Drawn from HV Pin (I_{HV}) vs. Temperature

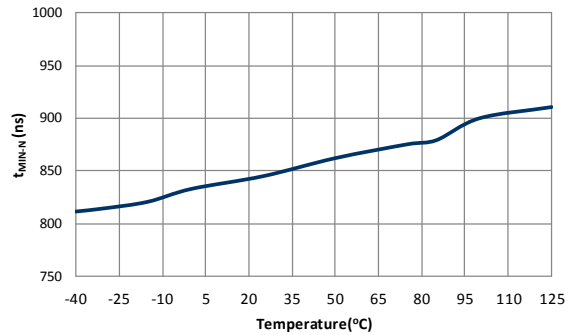


Figure 15. Minimum On Time at No Load (t_{MIN-N}) vs. Temperature

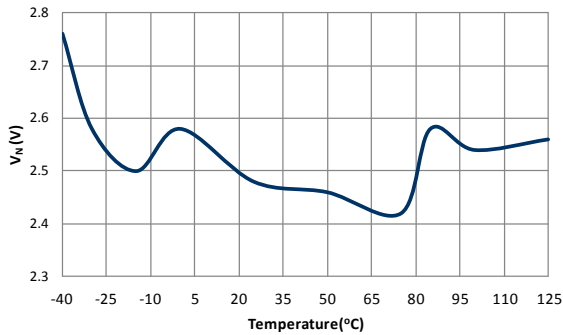


Figure 16. Green Mode Starting Voltage on EA_V (V_N) vs. Temperature

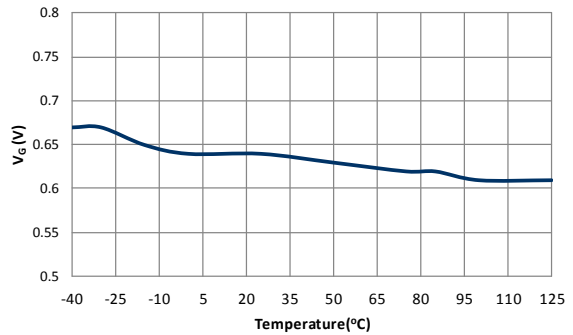


Figure 17. Green Mode Ending Voltage on EA_V (V_G) vs. Temperature

Typical Performance Characteristics

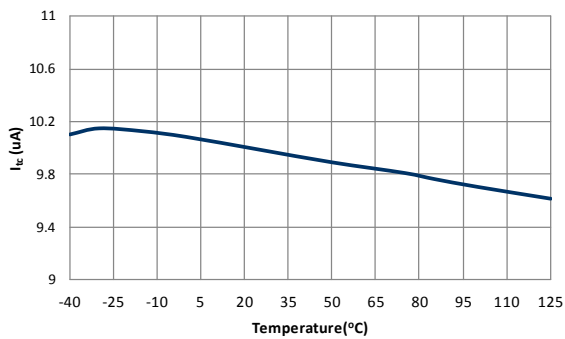


Figure 18. IC Bias Current (I_{ic}) vs. Temperature

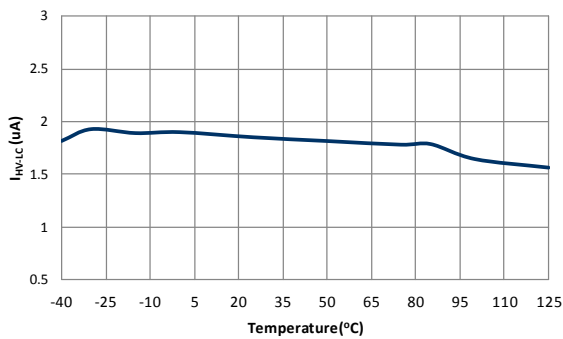


Figure 19. Leakage Current after Startup (I_{HV-LC}) vs. Temperature

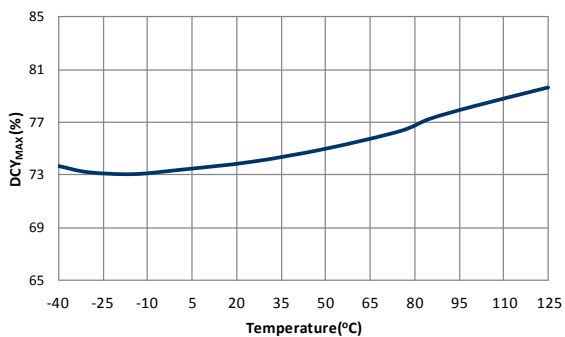


Figure 20. Maximum Duty Cycle (DCY_{MAX}) vs. Temperature

Operating Current

The FLS6617 operating current is as small as 2.5 mA, which results in higher efficiency and reduces the V_{DD} hold-up capacitance requirement. Once FLS6617 enters “deep” green mode, the operating current is reduced to 0.95 mA, assisting the power supply in meeting power conservation requirements.

Green-Mode Operation

The FLS6617 uses voltage regulation error amplifier output (V_{COMV}) as an indicator of the output load and modulates the PWM frequency as shown in Figure 23. The switching frequency decreases with cycle skipping as the load decreases. In heavy load conditions, the switching frequency is fixed at 50 kHz. Once V_{COMV} decreases below V_N , the PWM frequency linearly decreases with cycle skipping from 50 kHz to reduce switching losses.

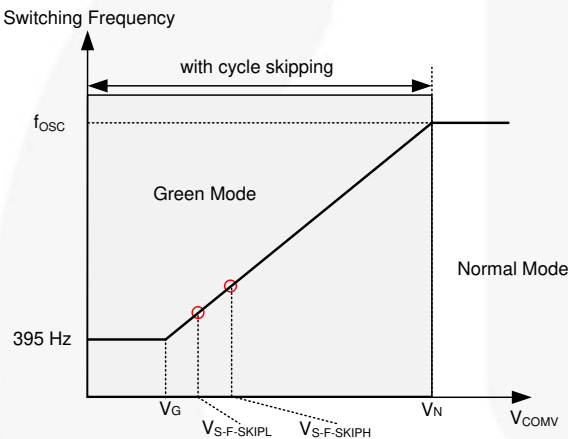


Figure 23. Switching Frequency in Green Mode

Frequency Hopping

EMI reduction is accomplished by frequency hopping, which spreads the energy over a wider frequency range than the bandwidth measured by the EMI test equipment. FLS6617 has a proprietary internal frequency hopping circuit that changes the switching frequency between 44 kHz and 56 kHz.

High-Voltage Startup

Figure 24 shows the HV-startup circuit for FLS6617 applications. The HV pin is connected to the line input or bulk capacitor through a resistor, R_{START} (100 k Ω recommended). During startup status, the internal startup circuit is enabled. Meanwhile, line input supplies the current, $I_{STARTUP}$, to charge the hold-up capacitor, C_{DD} , through R_{START} . When the V_{DD} voltage reaches V_{DD-ON} , the internal startup circuit is disabled, blocking $I_{STARTUP}$ from flowing into the HV pin. Once the IC turns on, C_{DD} is the only energy source to supply the IC consumption current before the PWM starts to switch. Thus, C_{DD} must be large enough to prevent V_{DD} from dropping down to V_{DD-OFF} before the power can be delivered from the auxiliary winding.

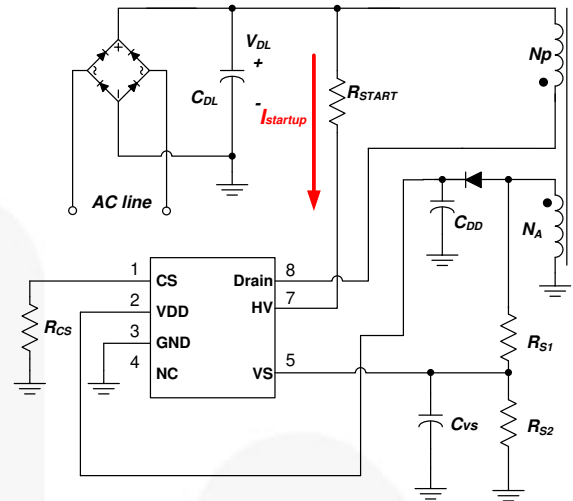


Figure 24. HV Startup Circuit

Under-Voltage Lockout (UVLO)

The turn-on and turn-off thresholds are fixed internally at 16 V and 5 V, respectively. During startup, the hold-up capacitor must be charged to 16 V through the startup resistor to enable the FLS6617. The hold-up capacitor continues to supply V_{DD} until power can be delivered from the auxiliary winding of the main transformer. V_{DD} is not allowed to drop below 5 V during this startup process. This UVLO hysteresis window ensures that hold-up capacitor properly supplies V_{DD} during startup.

Protections

The FLS6617 has several self-protection functions, such as Over-Voltage Protection (OVP), Over-Temperature Protection (OTP), and pulse-by-pulse current limit. All the protections are implemented as auto-restart mode. Once the abnormal condition occurs, the switching is terminated and the MOSFET remains off, causing V_{DD} to drop. When V_{DD} drops to the V_{DD} turn-off voltage of 5 V, internal startup circuit is enabled again and the supply current drawn from the HV pin charges the hold-up capacitor. When V_{DD} reaches the turn-on voltage of 16 V, normal operation resumes. In this manner, the auto-restart alternately enables and disables the switching of the MOSFET until the abnormal condition is eliminated (see Figure 25).

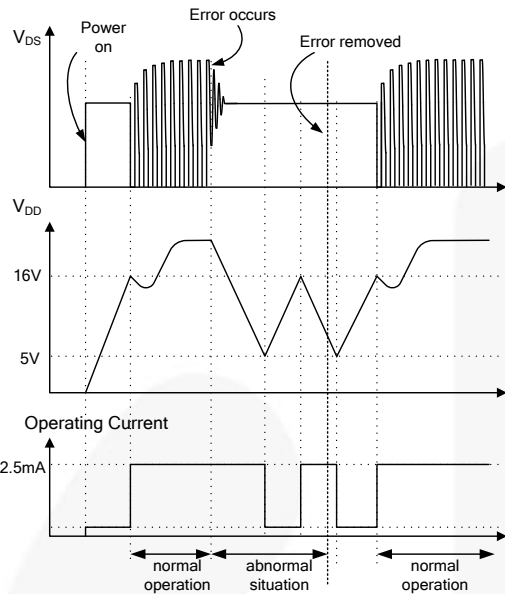


Figure 25. Auto-Restart Operation

V_{DD} Over-Voltage Protection (OVP)

V_{DD} over-voltage protection prevents damage from over-voltage conditions. If the V_{DD} voltage exceeds 24 V at open-loop feedback condition, OVP is triggered and the PWM switching is disabled. The OVP has a debounce time (typically 200 μs) to prevent false triggering due to switching noises.

Over-Temperature Protection (OTP)

The built-in temperature-sensing circuit shuts down PWM output if the junction temperature exceeds 140°C.

Pulse-by-pulse Current Limit

When the sensing voltage across the current-sense resistor exceeds the internal threshold of 0.8 V, the MOSFET is turned off for the remainder of switching cycle. In normal operation, the pulse-by-pulse current limit is not triggered since the peak current is limited by the control loop.

Leading-Edge Blanking (LEB)

Each time the power MOSFET switches on, a turn-on spike occurs at the sense resistor. To avoid premature termination of the switching pulse, a leading-edge blanking time is built in. During this blanking period, the current-limit comparator is disabled and cannot switch off the gate driver. As a result conventional RC filtering can be omitted.

Gate Output

The FLS6617 output stage is a fast totem-pole gate driver. Cross conduction has been avoided to minimize heat dissipation, increase efficiency, and enhance reliability. The output driver is clamped by an internal 15 V Zener diode to protect the power MOSFET transistors against undesired over-voltage gate signals.

Built-In Slope Compensation

The sensed voltage across the current-sense resistor is used for current mode control and pulse-by-pulse current limiting. Built-in slope compensation improves stability and prevents sub-harmonic oscillations due to peak-current mode control. The FLS6617 has a synchronized, positive-slope ramp built-in at each switching cycle.

Noise Immunity

Noise from the current sense or the control signal can cause significant pulse width jitter, particularly in continuous-conduction mode. While slope compensation helps alleviate these problems, further precautions should still be taken. Good placement and layout practices should be followed. Avoiding long PCB traces and component leads, locating compensation and filter components near the FLS6617, and increasing the power MOS gate resistance are advised.

Operation Area

Figure 26 shows operation area. FLS6617 has two switching frequency (f_s) in constant current mode. In order to ensure IC can normally work at DCM under constant current mode, frequency will jump to lower level(36 kHz) when system is operated at low output voltage.

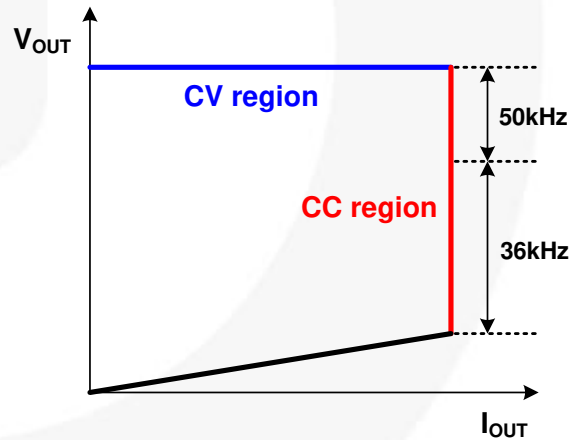
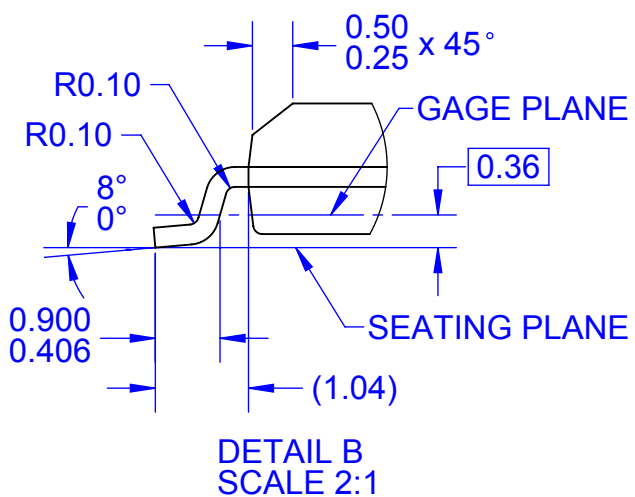
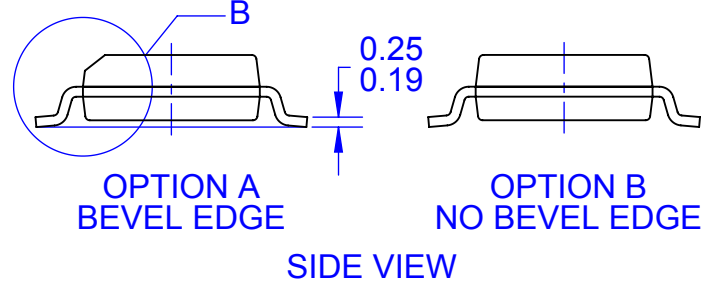
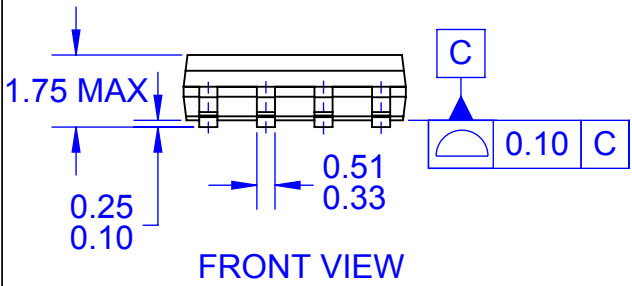
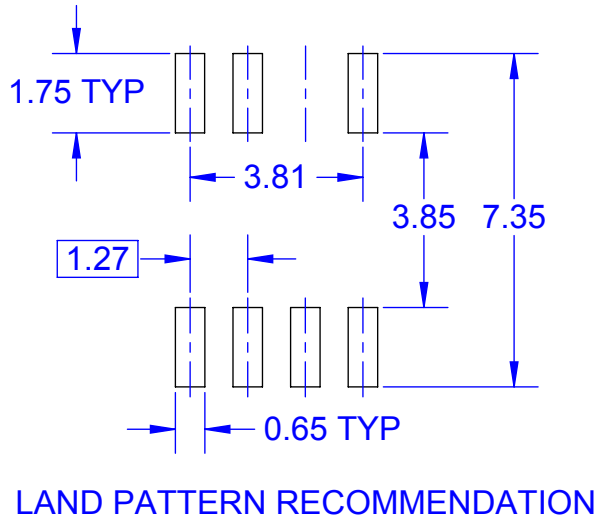
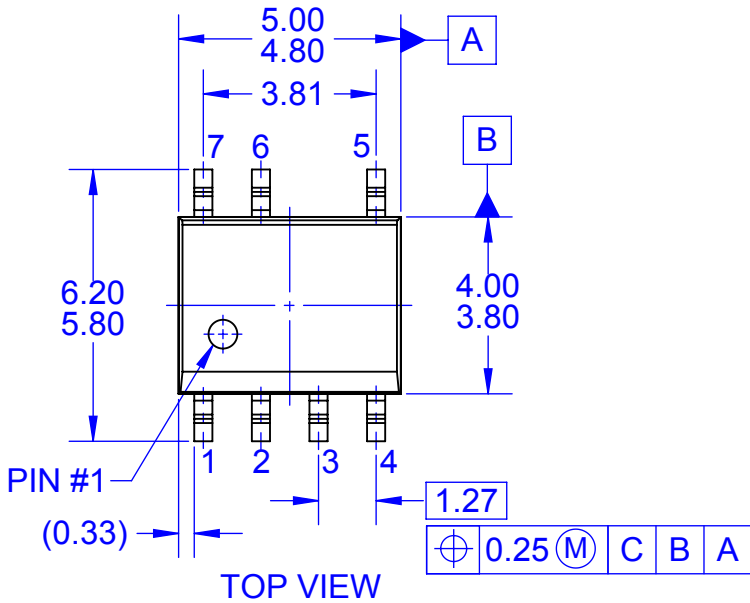


Figure 26. Operation Area



- NOTES:
- A. THIS PACKAGE DOES NOT FULLY CONFORM TO JEDEC MS-012, VARIATION AA
 - B. ALL DIMENSIONS ARE IN MILLIMETERS
 - C. DIMENSIONS DO NOT INCLUDE MOLD FLASH OR BURRS
 - D. DRAWING FILENAME: MKT-M07Brev4



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